502638128 01/16/2014

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2684736

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HIREN D. THACKER	12/10/2013
JOHN E. CUNNINGHAM	12/12/2013

RECEIVING PARTY DATA

Name:	ORACLE INTERNATIONAL CORPORATION
Street Address:	500 ORACLE PARKWAY
Internal Address:	MAIL STOP 50P7
City:	REDWOOD CITY
State/Country:	CALIFORNIA
Postal Code:	94065

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14109616

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	ORA14-0087-US-NP1
NAME OF SUBMITTER:	A. RICHARD PARK, REG. NO. 41,241
Signature:	/A. Richard Park/
	PATENT

502638128 REEL: 031982 FRAME: 0271

Date:	01/16/2014
Total Attachments: 2 source=ORA14-0087-US-NP1_Assignment#page1.tif source=ORA14-0087-US-NP1_Assignment#page2.tif	

PATENT REEL: 031982 FRAME: 0272

CORPORATE ASSIGNMENT

WHEREAS, the undersigned,

Hiren D. Thacker John E. Cunningham

4185 Porte De Merano #154, San Diego, CA 92122 12213 Carmel Vista Road, Apt. 233, San Diego, CA 92130

hereinafter termed "Inventor(s)", have invented certain new and useful improvements in

ELECTROPLATED SOLDER FOR HIGH-TEMPERATURE INTERCONNECT

and hav	ve executed a declaration or oath for an application for a United States patent disclosing and ving the invention:
_	On the, 20;
	Or
X	Said application having Application Number 14/109, 616 and filed on 17 Dec. Pand 3
	WHEREAS, Oracle International Corporation, a corporation of the State of California, having a
place of	f business at 500 Oracle Parkway, Mail Stop 50P7, Redwood City, CA 94065, (hereinafter termed
"Assign	nee"), is desirous of acquiring the entire right, title and interest in and to said application and the
invention	on disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or
	red jointly or severally by said Inventor(s) (all collectively hereinafter termed "said invention"),

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventor(s) to have been received in full from said Assignee:

and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed

"patents") thereon granted in the United States and foreign countries.

- 1. Said Inventor(s) do hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.
- 2. Said Inventor(s) hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventor(s) shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority

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contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor(s) in providing such cooperation shall be paid for by said Assignee.

- 3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor(s), their respective heirs, legal representatives and assigns.
- 4. Said Inventor(s) hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, said Inventor(s) have executed and delivered this instrument to said Assignee as of the dates written below.

- Humbleha	12/10/2073	
Hiren D. Thacker	Date	
John & Camman	12/12/2013	
John E. Cunningham	Date	
	Date	
	Date	
	Date	

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